Effective February 2021 Supersedes December 2020

CMLA

Automotive grade common-mode noise suppressor chip inductor



Product features

- AEC-Q200 qualified
- Square type closed magnetic core allows smaller inductor
- · Low profile design
- 700 ohm impedance in 3 sizes
- Excellent impedance characteristics to suppress common and differential-mode noise
- Moisture sensitivity level (MSL): 1

Applications

- · Automotive power line filter
- Automotive equipment and devices
- Infotainment
- ECU Power filtering
- LED Lighting
- DC power lines
- Multi-media devices

Environmental compliance and general specifications

- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant





Product specifications

Part number ³	Common-mode impedance¹ (Ω) typical	Common-mode impedance¹ (Ω) minimum	DCR (mΩ) @ +25 °C maximum	Rated current² (A) maximum	Rated voltage (Vdc) maximum	Insulation resistance @ 100 Vdc (MΩ) minimum
CMLA0706-701-R	700	500	15	4.0	100	10
CMLA0907-701-R	700	500	10	5.0	100	10
CMLA1211-701-R	700	500	6.0	8.0	100	10

1. Common-mode impedance test parameters: 100 MHz, 0.1 Vrms, +25 $^{\circ}\text{C}$

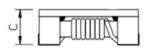
 Rated current: DC current for an approximate temperature rise of 40 °C without core loss. It is recommended that the temperature of the part not exceed +125 °C under worst case operating conditions verified in the end application. 3. Part Number Definition: CMLAxxxx-yyy-R

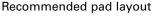
CMLA = Product code

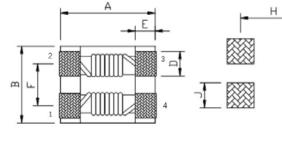
xxx= Size indicator yyy= Impedance value in ohms. R= decimal point, if no R is present then last digit indictaes the number of zeros -R suffix = RoHS compliant

Mechanical parameters, schematic, pad layout (mm)







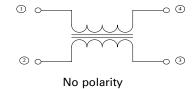


Part marking: xxx= Impedance value in ohms All soldering surfaces to be coplanar within 0.1 millimeters Tolerances are ±0.3 millimeters unless stated otherwise Pad layout tolerances are ±0.1 millimeters unless stated otherwise Pad layout dimensions are reference only

Traces or vias underneath the inductor is not recommended

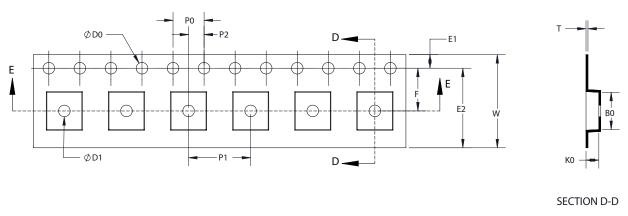
Dimension CMLA0706-701-R CMLA0907-701-R CMLA1211-701-R А 8.0 maximum 10 maximum 13 maximum В 6.2 maximum 7.5 maximum 11.5 maximum С 4.0 maximum 4.8 maximum 7.0 maximum D 2.7 ±0.3 1.5 ±0.3 1.8 ±0.3 Ε 1.7 ±0.3 1.7 ±0.3 2.57 ±0.3 F 3.0 ref 3.8 ref 5.2 ref G 3.0 ref 3.8 ref 5.2 ref Н 5.2 ref 7.3 ref 9.32 ref 3.0 ref 2.7 ref 3.6 ref Т J 2.0 ref 2.0 ref 3.2 ref

Equivalent circuit



Packaging information (mm)

Supplied in tape and reel packaging, 13" diameter reel (EIA-481 compliant) CMLA0706-xxx-R 1100 parts per reel, CMLA0907-xxx-R 800 parts per reel, CMLA1211-xxx-R 500 parts per reel

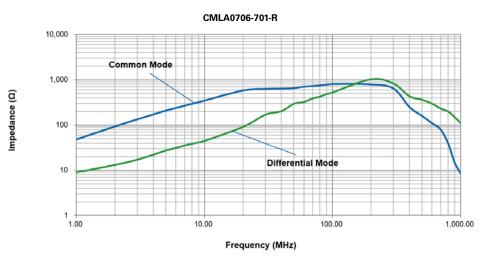




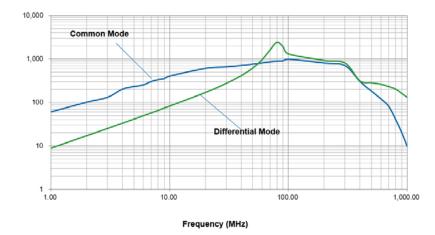
Dimension	CMLA0706-701-R	CMLA0907-701-R	CMLA1211-701-R
W	24 ±0.3	24 ±0.3	24 ±0.3
F	11.5 ±0.1	11.5 ±0.1	11.5 ±0.1
E1	1.75 ±0.1	1.75 ±0.1	1.75 ±0.1
E2	na	na	na
PO	4.0 ±0.1	4.0 ±0.1	4.0 ±0.1
P1	12 ±0.1	12 ±0.1	16 ±0.1
P2	2.0 ±0.1	2.0 ±0.1	2.0 ±0.1
DO	1.5 +0.1/-0	1.5 +0.1/-0	1.5 +0.1/-0
D1	na	na	1.5
A0	6.5 ±0.2	7.6 ±0.1	11.2 ±0.2
BO	8.3 ±0.2	9.6 ±0.1	12.9 ±0.2
КО	4.4 ±0.2	5.0 ±0.1	7.0 ±0.2
Т	0.4 ±0.05	0.4 ±0.05	0.4 ±0.05

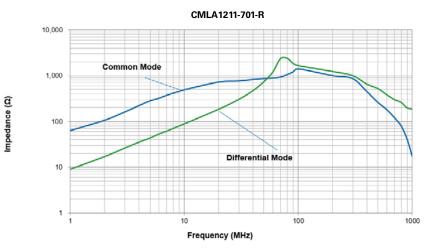
Impedance vs frequency

Impedance (Ω)

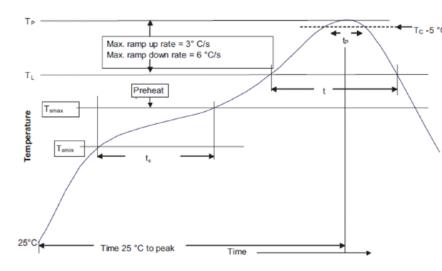


CMLA0907-701-R





Solder reflow profile



 T_c -5 °C Table 1 - Standard SnPb solder (T_c)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm)	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_c)

Package thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Powering Business Worldwide

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T _{smin})	100 °C	150 °C
• Temperature max. (T _{smax})	150 °C	200 °C
• Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds
Ramp up rate TL to Tp	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (TL) Time (tL) maintained above ${\rm T_L}$	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (Tp)*	Table 1	Table 2
Time $(t_p)^*$ within 5 °C of the specified classification temperature (T_c)	20 seconds*	30 seconds*
Ramp-down rate (Tp to TL)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

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Eaton Electronics Division

1000 Eaton Boulevard Cleveland, OH 44122 United States Eaton.com/electronics

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